# The Digital Sealing Solution



High-Speed HFFS Pouch Making Application

## **Challenges**

for mono-material processing

- Start-up losses
- Deformed and shrinked seals and packaging
- Slow sealing system response to speed change
- Damaged packaging during machine stops due to continuos heat contact



## watttrons Solution

### **Benefits**



Mono-material processing



**Energy saving** 



Fast ramp-up and cool down

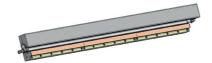


Easy machine integration



Increase quality and output

1 Bottom Sealing



2 Vertical Sealing



## **Technology DeepDive**



### Precise temperature control

Localized heat application via individually controlled pixels enables variable temperature zones, such as for sealing layer steps or a homogeneous sealing area.

ΔT < 2 °C accuracy for each pixel enables the processing of mono-materials and reduces adhesion and need for teflon.

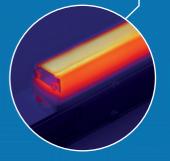


See Demonstration Video



## Heat only at the sealing surface

Reduced electricity consumption and decreased thermal impact on the machine.



## **Intuitive Graphic User Interface**



#### **Contact**

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